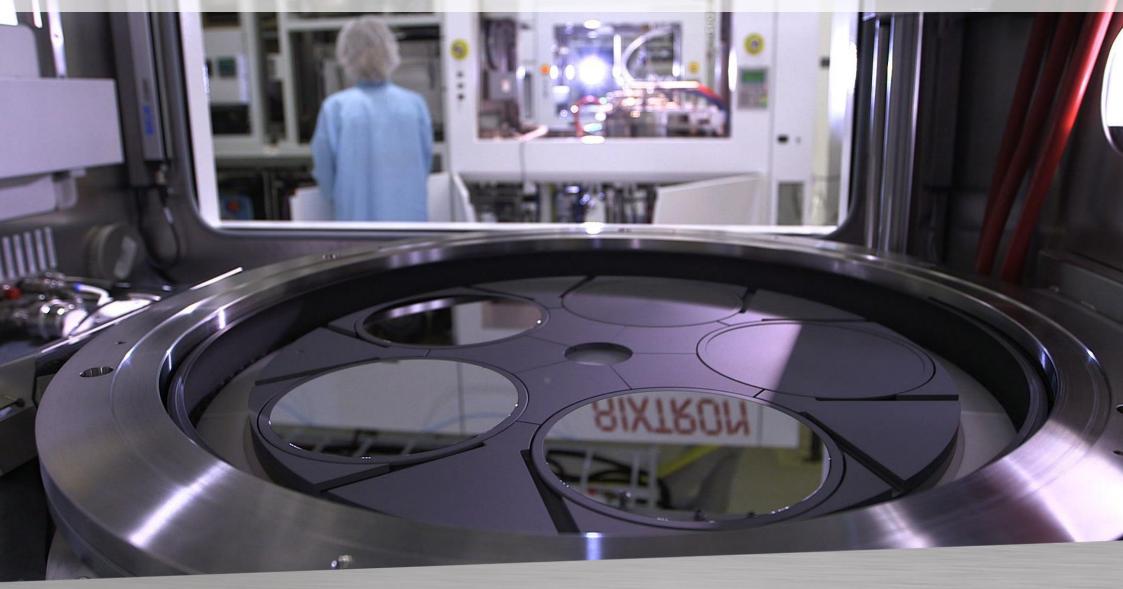
AIXTRON Investor Presentation



IR Presentation – First Quarter 2021



DISCLAIMER 2

Forward-Looking Statements

This document may contain forward-looking statements regarding the business, results of operations, financial condition and earnings outlook of AIXTRON. These statements may be identified by words such as "may", "will", "expect", "anticipate", "contemplate", "intend", "plan", "believe", "continue" and "estimate" and variations of such words or similar expressions. These forward-looking statements are based on the current assessments, expectations and assumptions of the executive board of AIXTRON, of which many are beyond control of AIXTRON, based on information available at the date hereof and subject to risks and uncertainties. You should not place undue reliance on these forward-looking statements. Should these risks or uncertainties materialize, or should underlying expectations not occur or assumptions prove incorrect, actual results, performance or achievements of AIXTRON may materially vary from those described explicitly or implicitly in the relevant forward-looking statement. This could result from a variety of factors, such as those discussed by AIXTRON in public reports and statements, including but not limited those reported in the chapter "Risk Report". AIXTRON undertakes no obligation to revise or update any forward-looking statements as a result of new information, future events or otherwise, unless expressly required to do so by law. This document is an English language translation of a document in German language. In case of discrepancies, the German language document shall prevail and shall be the valid version.

Due to rounding, numbers presented throughout this report may not add up precisely to the totals indicated and percentages may not precisely reflect the absolute figures for the same reason.

Our registered trademarks: AIXACT®, AIXTRON®, APEVA®; Atomic Level SolutionS®, Close Coupled Showerhead®, CRIUS®, EXP®, EPISON®, Gas Foil Rotation®, Optacap™, OVPD®, Planetary Reactor®, PVPD®, STExS®, TriJet®



ABOUT AIXTRON

Our Vision

Technology. Materials. Performance.

Technology.

We are the **recognized technology leader** in complex material deposition.

Materials.

We **enable our customers** to
successfully shape the
markets of the future,
exploiting the potential
offered by **new materials**.

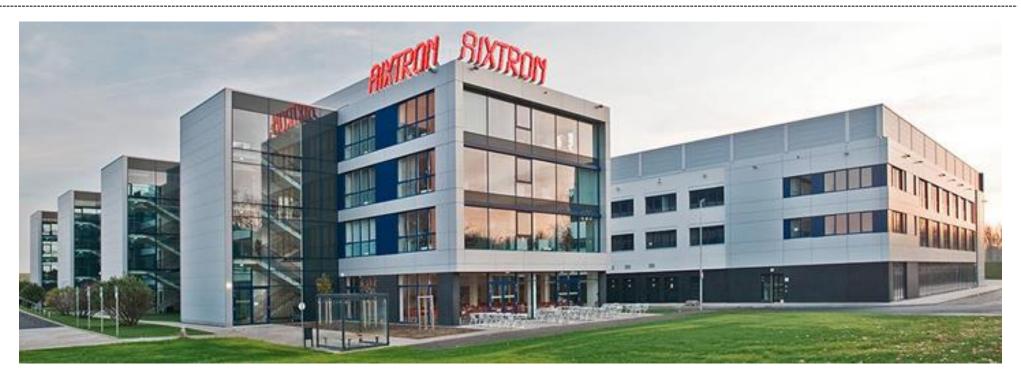
Performance.

We deliver the performance driving economic success through our expertise, our employees and the quality of our products.



ABOUT AIXTRON

Who we are

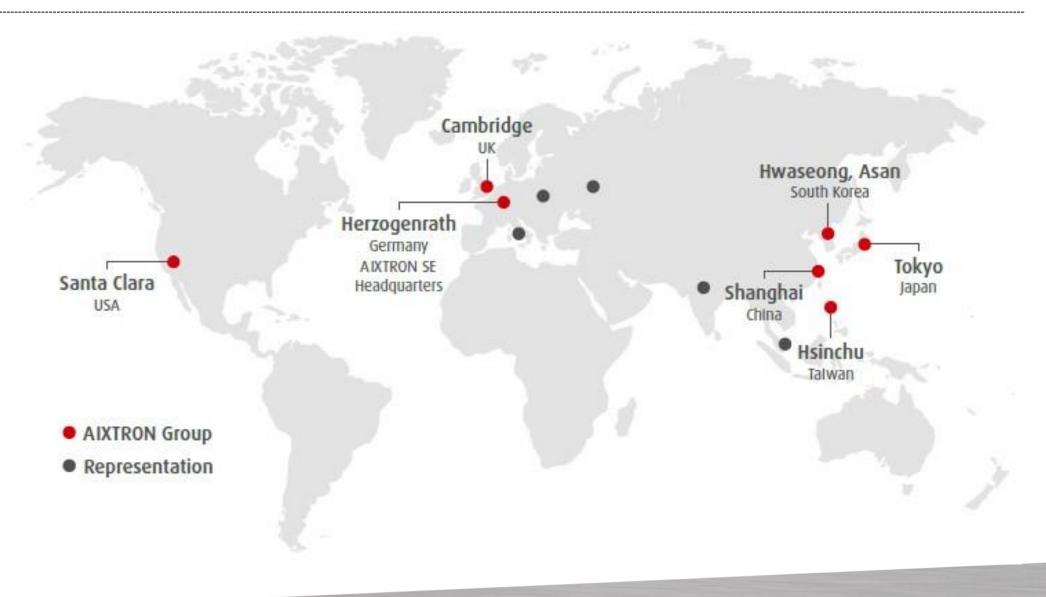


- Headquarters based near Aachen, Germany
- Worldwide presence in 7 countries
- R&D and production facilities in Germany and UK
- over 700 employees

- Company founded in 1983, >35 years of experience
- Technology leader in deposition systems
- Over 3,500 deposition systems sold worldwide
- Went public in 1997, listed in TecDAX and MDAX



Where we are



ABOUT AIXTRON 6

What We Do



We provide enabling **Deposition Technologies to the Compound Semiconductor and Display Industry**

For Optoelectronics and Power Electronics

- Metal-Organic Chemical Vapor Deposition (MOCVD)
 for the deposition of compound materials to produce for
 instance Lasers, LEDs, GaN and SiC Power Electronics or
 other Optoelectronic components
- Plasma-enhanced Chemical Vapor Deposition (PECVD) for the deposition of Carbon Nanostructures and 2D materials (Carbon Nanotubes, Nanowires or Graphene)

For Organic Electronics Applications

*These thin film deposition technologies are offered by AIXTRON's subsidiary APEVA.



Power Management

Technology Portfolio for Complex Material Deposition

OLED: OVPD®/PVPD®





Nanomaterials

NANO: Innovation Pool



Lasers (VCSEL/EEL)

(e.g. 3D Sensing, Lidar, Consumer Electronics, Optical Datacom)



GaN Power | GaN/GaAs RF

(e.g. Wireless Charging, Fast Charging, Power Supply, 5G Network, Consumer Electronics)



Specialty LEDs

(e.g. Fine Pitch-, MiniLED-Displays & Backlighting, UV-LED Disinfection, Micro LED-Displays, Horticulture)



SiC Power

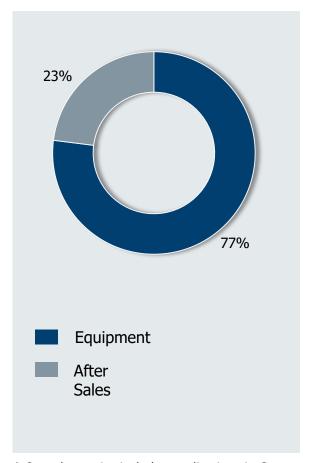
(e.g. Electric Vehicles, Charging Stations, Infrastructure)

MOCVD Core Technology

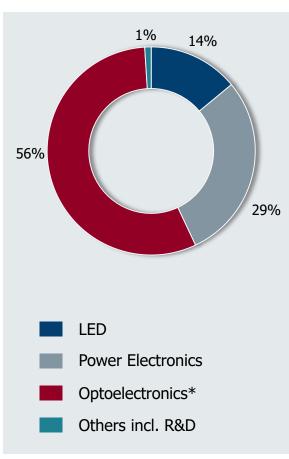


Revenue Analysis*

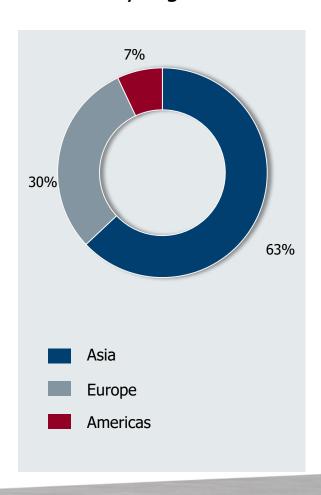
Q1/2021: by equipment & after sales



Q1/2021: by end application (equipment only)



Q1/2021: by region





 $[\]hbox{* Optoelectronics includes applications in Consumer Optoelectronics, Telecom/Datacom\ and\ Solar}\\$

FINANCIALS

24 - Month Business Development

(€ million)

Order Intake (incl. Equipment & After Sales)

Order Backlog (Equipment only)

Revenues (incl. Equipment & After Sales)



USD order intake and backlog were recorded at the prevailing budget rate (2019-2020: \$1.20€; 2021: \$1.25/€)
USD revenues were converted at the actual period average FX rate (Q2-Q4/2019: \$1.11/€; 2020: \$1.14/€; Q1/2021: \$1.22/€)



Consolidated Income Statement*

(€ million)	Q1/21	Q1/20	+/- %	Q1/21	Q4/20	+/- %
Revenues	49.5	41.0	21	49.5	108.1	-54
Cost of sales	32.2	26.4	22	32.2	63.1	-49
Gross profit	17.3	14.6	18	17.3	45.0	-62
%	<i>35</i>	<i>36</i>	-1 pp	35	42	-7 pp
Selling expenses	2.2	2.7	-18	2.2	2.4	-9
General & admin expenses	5.6	4.8	18	5.6	4.2	33
R&D	11.9	14.4	-18	11.9	17.2	-31
Net other operating income	(1.7)	(6.2)	-72	(1.7)	(3.3)	-47
EBIT	-0.7	-1.1	36	-0.7	24.5	-103
%	-1	-3	2 pp	-1	23	-24 pp
Net result	3.8	-0.8	575	3.8	24.9	-85
%	8	-2	10 pp	8	23	-15 pp



Balance Sheet*

(€ million)	31/03/21	31/12/20	31/03/20
Property, plant & equipment	65.4	63.5	65.9
Goodwill	71.9	71.0	72.2
Other intangible assets	2.4	2.9	2.8
Others**	79.9	74.9	11.9
Non-current assets	219.6	212.2	152.8
Inventories	97.3	79.1	85.2
Trade receivables	42.6	41.3	17,1
Others	14.3	8.1	9.7
Cash & Cash Deposits & Investments	281.0	249.7	300.8
Current Assets	435.2	378.2	412.8
Equity	505.0	496.4	462.9
Non-current liabilities	7.8	6.6	4.1
Trade payables	15.6	10.8	15.9
Contract liabilities for advance payments	100.6	50.8	60.2
Others	25.8	25.8	22.4
Current liabilities	141.9	87.5	98.5
Balance Sheet total	654.8	590.4	565.6

^{**} Includes cash deposits of EUR 60m in Q1/2021 and Q4/2020



Consolidated Statement of Cash Flows*

(€ million)	Q1/21	Q1/20	Q1/21	Q4/20
Net Result	3.8	(0.8)	3.8	24.9
Adjust for				
Non Cash Items	(1.6)	(0.1)	(1.6)	2.0
Changes in Working Capital	29.6	5.6	29.6	(8.5)
Cash Flow from Operating Activities**	31.8	4.7	31.8	18.4
Capital Expenditures/Disposals	(3.7)	(1.7)	(3.7)	(1.1)
Free Cash Flow	28.1	3.0	28.1	17.3
FX Effects/Other	3.2	(0.4)	3.2	(0.2)
Cash, financial investments & deposits	341.0	300.8	341.0	309.7

^{**} Excludes changes in financial assets



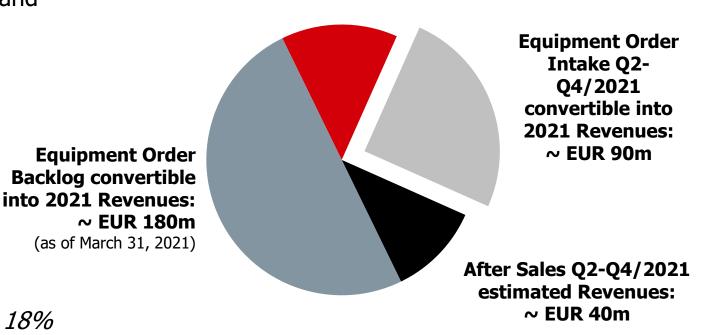
AIXTRON - 2021 Guidance*: Confirmed/Increased

2021 Guidance*
confirmed/increased based on Q1
Results, current Order situation and
current environment:

- Total Order Intake
 around upper end of range
 of EUR 340 ~ 380 million
- Revenues

 around upper end of range
 of EUR 320 ~ 360 million
- Gross Margin of $\sim 40\%$
- EBIT Margin expected at ~ 18% (from ~ 16%)

Q1/2021 Revenues: EUR 50m



 At 1.25 USD/EUR Budget Rate for the remainder of the year; please refer to "Expected Results of Operations and Financial Position" in the AIXTRON 2020 Annual Report for further information



AIXTRON – Q1/2021 Highlights

√ High order momentum

Q1-Orders largely driven by GaN Power and 5G Wireless Telecom

√ Q1-Revenues in line with expectation - acceleration in the course of 2021

• Q1/2021 Revenues below previous quarter due to many customer requests for shipments to be pulled forward into Q4/2020; 2021 quarterly Revenues to accelerate each of the quarters

√ 2021 Guidance* confirmed/increased Orders and Revenues at upper end of range

- Orders 2021: around upper end of EUR 340 ~ 380 million range
- Revenues 2021: around upper end of EUR 320 ~ 360 million range
- Gross Margin: ∼ 40% of Revenues; EBIT Margin: increased to ∼ 18% of Revenues from 16%

✓ APEVA to address business opportunities in China

- Focus on key components of deposition technology
- Customer agreement not expected before 2022

✓ New Chief Financial Officer to start in May 2021

Dr. Christian Danninger will take up his position on May 1st, 2021

FUTURE MARKETS

Market Prospects

Short-Term

- Increasing adoption of compound semiconductor-based lasers for 3D sensor systems in mobile devices as well as sensors for infrastructure applications.
- Further increasing demand for lasers for optical data transmission of large volumes, such as for video streaming and Internet-of-Things (IoT) applications.
- Increasing use of LEDs and specialty LEDs (esp. Red-Orange-Yellow, UV or IR) in displays, disinfection, horticulture and other applications.
- Increasing use of wide-band gap GaN- or SiC-based components for energy-efficient power electronics devices in autos, in consumer electronics, in mobile devices and in IT infrastructure.
- Increasing use of GaN and GaAs-based components in mobile devices (e.g. Smartphones) or network infrastructure for 5G mobile communications.

Mid- to Long-Term

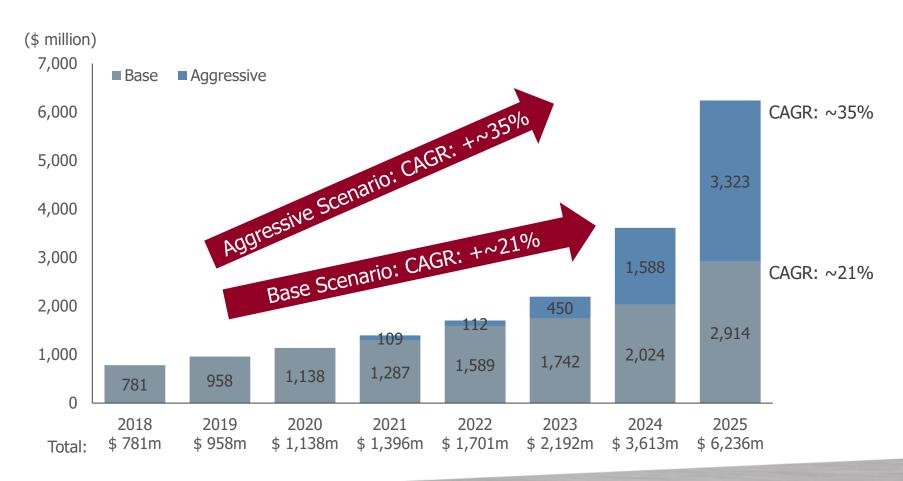
- Development of new applications based on wide-band gap materials such as high-frequency chips or system-on-chip architectures with integrated power management.
- Adoption of Micro LED Displays for volume markets.
- Development of alternative LED applications, such as visual-light communication technology.
- Increased use of compound semiconductor-based sensors for autonomous driving.
- Increased development activities for high performance solar cells made of compound semiconductors.
- Application of GaN-based components in mobile devices (e.g. smartphones) for the millimeter-wave range of 5G and 6G mobile communications.



Epitaxial Growth Equipment Market Forecast*

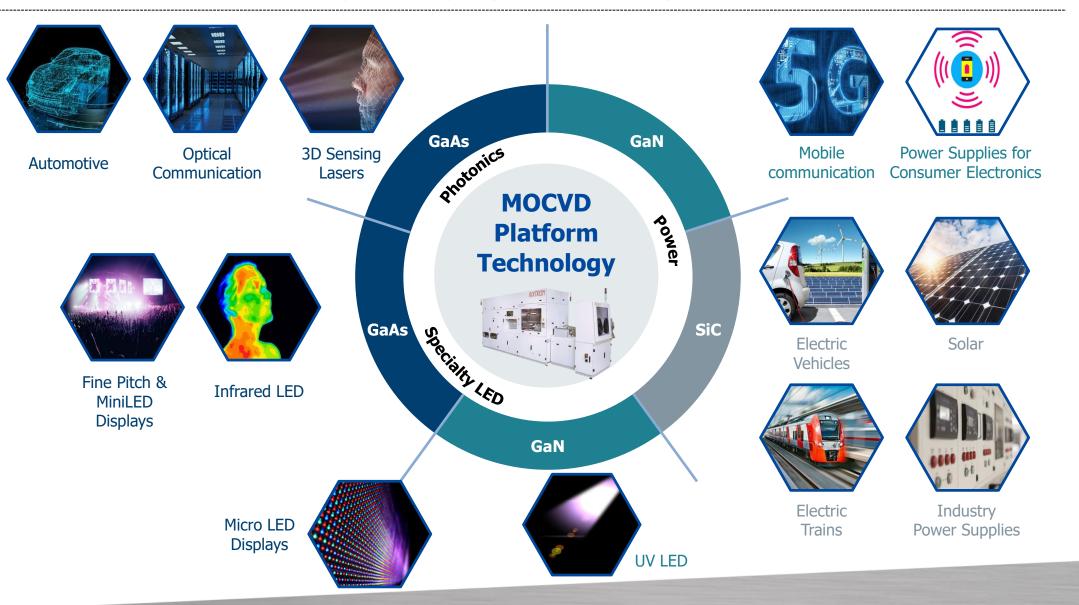
* Excluding MBE

- ✓ Micro LED equipment demand as strongest driver from 2021 (Aggressive Model)
- ✓ Power equipment demand to accelerate from 2021





AIXTRON – Enabling Emerging Global Mega Trends





AIXTRON MOCVD – Planetary Reactor®: Tool-of-Record

- ✓ Individual Wafer Rotation = Best Material Uniformity
- ✓ Individual wafer temperature adjustment = Wafer Level Control/Optimization
- ✓ Highest Epi / Product Yield = Lowest Production Cost









Devices: GaN/SiC Power Electronics – Superior Performance



Energy Saving

Less Heat

Light Weight

Lower System Cost







EV-charging







Renewable Energy





Fast Charging





Low to Medium Voltages

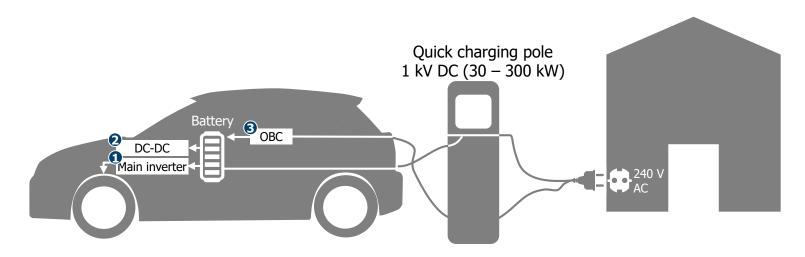
Overview: GaN/SiC as Wide Band Gap (WBG) Power Electronics

Consumer Electronics & IT Automotive Industrial Energy Power Management Power Switching 30V 600V 1.2 kV ≥2kV • UPS Infotainment General automotive Electronic appliances Power Grid / Smart meter / appliances Industrial machines Computing • GPS electronic • HEV/EV Solar / Wind inverters Building · Wireless charging · Connected car · Mining, oil, gas Charging station Solar / Wind power Power supplies · Autonomous driving DC distribution power generation • PFC • EMI/EMC • Inverter / motor drives • Shipping/Rail Converter storage Adaptive cruise control • UPS Radar test applications GaN / SiC SiC GaN

Medium to High Voltages



SiC in Automotive : Main Inverter as the Major Market Opportunity



Higher efficiency =

- ✓ Battery size reduction
- ✓ Cost savings
- ✓ Range extension

Component	Power (kW)	Fraction 6" wafer*	Comment
Main inverter	20 ~ 150	0.1 ~ 0.5	Brings energy from battery to the electric motor
DC-DC Converter	1 ~ 3	<0.01	Brings energy from battery for car electronics
On Board Charger (OBC)	5 ~ 30	0.01	Brings 240 V AC energy from wall plug to battery
(Quick) Charging Pole	30 ~ 300	0.1 ~ 1	Brings 1–3 kV DC energy directly from grid to battery

^{*} Back-of-the-envelope order-of-magnitude estimates



Devices: ROY LEDs for RGB* Displays; UV LEDs for Niche Markets

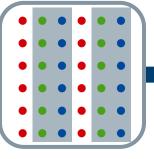
Source: LEDinside, Yole Développement

Initial

Introduction

Expected

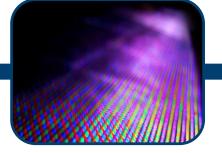
RGB* LED DISPLAYS











Stadium Outdoor Display

(Pixel Pitch ≥10mm) (Chip size: ≥ 200μm)

Fine Pitch Indoor Display

(Pixel Pitch ≤2.5mm) (Chip size: ≥ 200µm)

MiniLED for Consumer Electronics

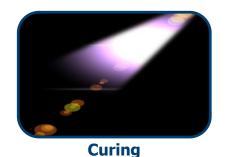
(Chip size: $\leq 200 \mu m$)

Micro LED for Consumer Electronics

(Chip size: $\leq 50\mu m$)





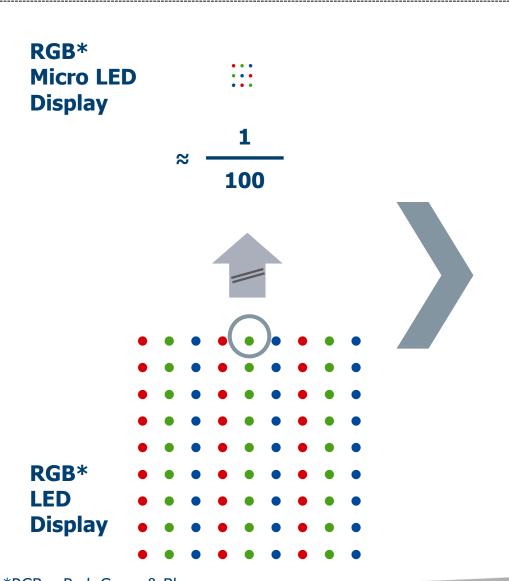






Water Disinfection Air Purifier

Devices: Micro LED – The Perfect Future Display Technology



Self-Emissive

Low Power Consumption

Perfect Contrast

High Brightness

Fast Response



Wearables



AR/VR

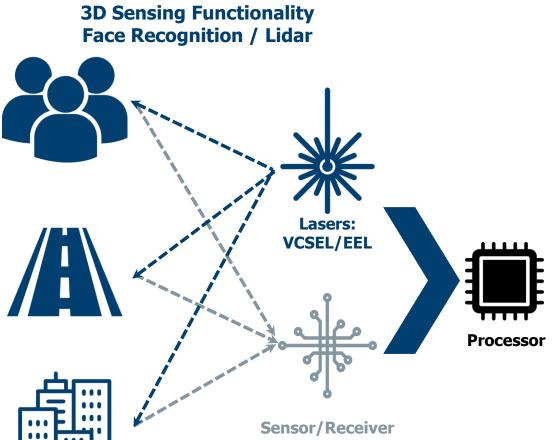


Signage



Smartphones/Tablets/TVs

Devices: VCSEL/EEL – Internet of Things Creates New Opportunities





Facial Recognition



Autonomous Driving



Tailor-made clothing/shoes



Interior Design



Mapping



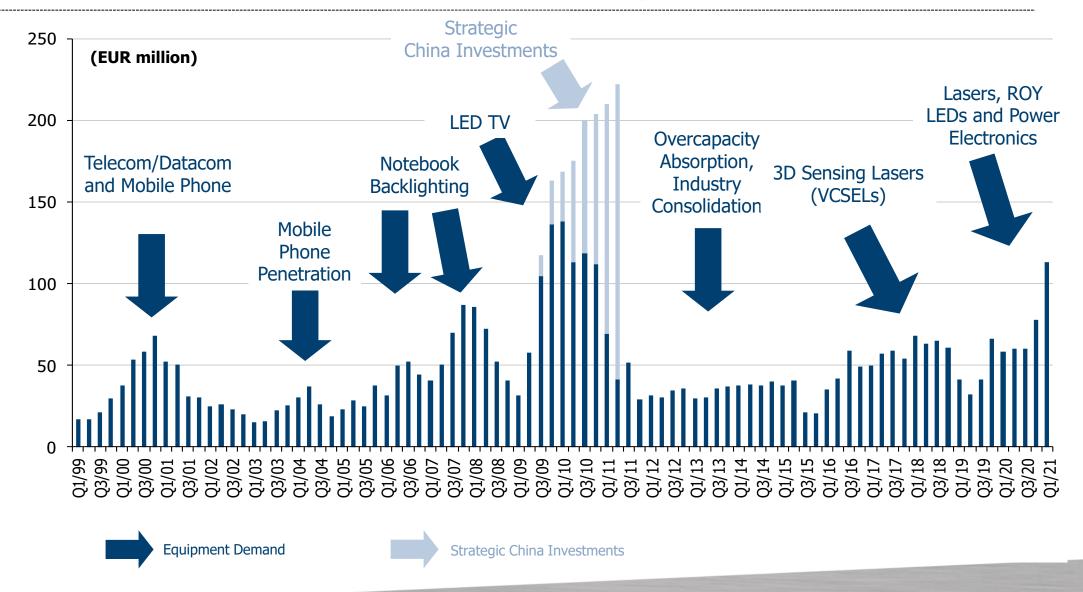
Industry 4.0

AIXTRON INVESTOR PRESENTATION 25

Our technology. YOUR FUTURE.



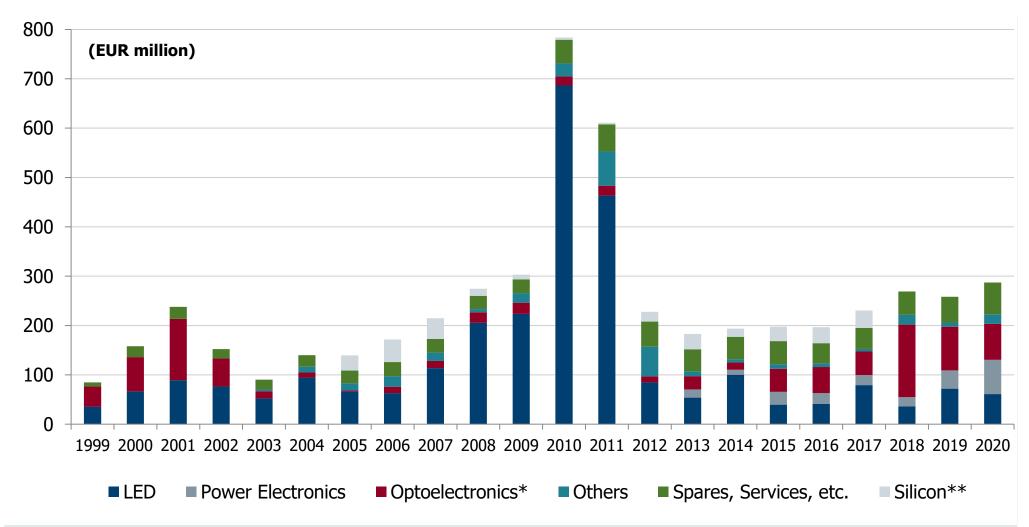
Demand Drivers on Order Intake per Quarter (Equipment Only)





FINANCIALS

Annual Total Revenues by Application (including After Sales)



^{*} Optoelectronics includes applications in Consumer Optoelectronics, Telecom/Datacom and Solar



^{**} Silicon: ALD/CVD product line sold in 2017

AIXTRON Competitive Landscape

		USA	Europe	China	Korea	Japan
Opto	GaAs/InP Optoelectronics, ROY LED	Veeco				TAIYO NIPPON SANSO The Gas Professionals
	GaN LED	Veeco		**TOPEC		TAIYO NIPPON SANSO The Gas Professionals
Power	GaN Power	Veeco				TAIYO NIPPON SANSO The Gas Professionals
	SiC Power		L PE			TOKYO ELECTRON NUFLARE
OLED		APPLIED MATERIALS. **MATERIALS.** **Mateeva**			Your Artistic Solution	CANON TOKKI CORPORATION



Consolidated Income Statement*

(€ million)	2020	2019	2018
Revenues	269.2	259.6	268.8
Cost of sales	161.0	150.9	151.2
Gross profit	108.3	108.7	117.6
%	40%	42 %	44%
Selling expenses	9.7	9.9	9.4
General & admin expenses	18.0	16.5	18.4
R&D	58.4	55.0	52.2
Net other operating income	(12.6)	(11.6)	(3.8)
EBIT	34.8	39.0	41.5
%	13%	15%	<i>15</i> %
Net result	34.5	32.5	45.9
%	13%	13%	<i>17</i> %



Balance Sheet*

31/12/20	31/12/19	31/12/18
63.5	64.5	63.1
71.0	72.4	71.6
2.9	2.4	2.1
74.9	11.7	13.3
212.2	151.0	150.1
79.1	79.0	73.5
41.3	29.2	40.1
8.1	5.4	11.5
249.7	298.3	263.7
378.2	412.0	388.8
496.4	464.1	429.7
6.6	4.5	1.8
10.8	19.4	27.8
50.8	51.1	53.3
25.8	23.9	26.3
87.5	94.3	107.4
590.4	563.0	538.9
	63.5 71.0 2.9 74.9 212.2 79.1 41.3 8.1 249.7 378.2 496.4 6.6 10.8 50.8 25.8 87.5	63.5 64.5 71.0 72.4 2.9 2.4 74.9 11.7 212.2 151.0 79.1 79.0 41.3 29.2 8.1 5.4 249.7 298.3 378.2 412.0 496.4 464.1 6.6 4.5 10.8 19.4 50.8 51.1 25.8 23.9 87.5 94.3

^{**} Includes cash deposits of EUR 60m in Q4/2020



Consolidated Statement of Cash Flows*

(€ million)	2020	2019	2018
Cash Flow from operating activities	-39.2	42.8	11.9
Cash Flow from investing activities	-41.5	-6.8	-15.1
Cash Flow from financing activities	-0.9	-1.2	10.4
Exchange rate changes	-2.0	-0.1	2.4
Net change in Cash & Cash Equivalents	-83.6	34.6	9.7
Cash & Cash Equivalents (beginning of period)	270.8	236.2	226.5
Cash & Cash Equivalents (end of period)	187.3	270.8	236.2
Change in Cash deposits	32.5	0.0	7.5
Free Cash Flow	14.0	35.1	4.4
Capex	9.3	7.7	9.2



Financial Calendar & Contact Data

April 29, 2021 Q1/2021 Results, Conference Call

May 19, 2021 Virtual Annual General Meeting

July 29, 2021 H1/2021 Results, Conference Call

November 04, 2021 9M/2021 Results, Conference Call

February 24, 2022
 FY 2021 Results, Conference Call

For further information please contact:

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AIXTRON – Our technology. Your future.

